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July 2015

FDMC012N03

N-Channel Power Trench[®] MOSFET 30 V, 1.23 m Ω

Features

- Max $r_{DS(on)}$ = 1.23 m Ω at V_{GS} = 10 V, I_D = 35 A
- Max $r_{DS(on)}$ = 1.46 m Ω at V_{GS} = 4.5 V, I_D = 32 A
- High performance technology for extremely low r_{DS(on)}
- Termination is Lead-free
- RoHS Compliant



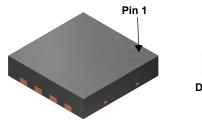
Bottom

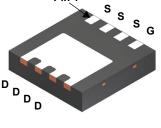
General Description

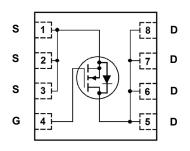
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

■ DC-DC Conversion







Top Power 33

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol		Paramet		Ratings	Units	
V_{DS}	Drain to Source \	/oltage			30	V
V_{GS}	Gate to Source V	oltage/			±12	V
	Drain Current	-Continuous	T _C = 25 °C	(Note 5)	185	
		-Continuous	T _C = 100 °C	(Note 5)	117	^
ID		-Continuous	T _A = 25 °C	(Note 1a)	35	Α
		-Pulsed		(Note 4)	688	
E _{AS}	Single Pulse Ava	lanche Energy		(Note 3)	337.5	mJ
P_{D}	Power Dissipation		T _C = 25 °C		64	W
	Power Dissipation	n	T _A = 25 °C	(Note 1a)	2.3	VV
T _J , T _{STG}	Operating and St	orage Junction Temperat	ure Range		-55 to +150	°C

Thermal Characteristics

R_{θ}	JC	Thermal Resistance, Junction to Case	(Note 1)	1.95	°C/W
R_{θ}	JA	Thermal Resistance, Junction to Ambient	(Note 1a)	53	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC012N03	FDMC012N03	Power33	13 "	12 mm	3000 units

Electrical Characteristics T_J = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
$\Delta BV_{DSS} \ \Delta T_{J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		21		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μА
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±12 V, V _{DS} = 0 V			±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	8.0	1.3	2.0	V
$\Delta V_{GS(th)} \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 250 μA, referenced to 25 °C		-4.5		mV/°C
r _{DS(on)}		$V_{GS} = 10 \text{ V}, I_D = 35 \text{ A}$		0.96	1.23	
	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 32 \text{ A}$		1.14	1.46	mΩ
		V_{GS} = 10 V, I_D = 35 A, T_J = 125 °C		1.36	1.77	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 \text{ V}, I_{D} = 35 \text{A}$		220		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V - 45 V V - 0 V		5845	8183	pF
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz		1440	2016	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 1011 12		94	132	pF
R_{a}	Gate Resistance		0.1	0.5	1	Ω

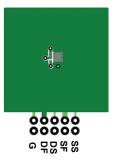
Switching Characteristics

t _{d(on)}	Turn-On Delay Time		16	29	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 35 A,	5.5	11	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω	43	69	ns
t _f	Fall Time		4.5	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V _{GS} = 0 V to 10 V	78	110	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V}$	35	50	nC
Q _{gs}	Gate to Source Charge	I _D = 35 A	11.5		nC
Q _{gd}	Gate to Drain "Miller" Charge		6		nC

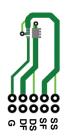
Drain-Source Diode Characteristics

V_{SD}	Source to Drain Dioge Forward Voltage	V _{GS} = 0 V, I _S = 35 A (Note 2)	0.8	1.3	V
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.7	1.2	V
t _{rr}	Reverse Recovery Time	I _E = 35 A, di/dt = 100 A/μs		45	80	ns
Q _{rr}	Reverse Recovery Charge	- 1 _F = 35 A, αι/αι = 100 A/μs		27.5	45	nC

^{1.} R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



53 °C/W when mounted on a 1 in² pad of 2 oz copper



130 °C/W when mounted on a minimum pad of 2 oz copper

- 2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.
- 3. E_{AS} of 337.5 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 15 A, V_{DD} = 30 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 47 A.
- 4. Pulsed Id please refer to Fig.11 SOA curve for more details.
- 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

Typical Characteristics T_J = 25 °C unless otherwise noted

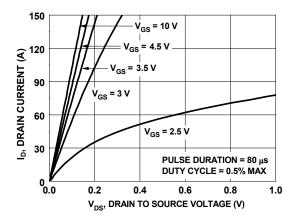


Figure 1. On Region Characteristics

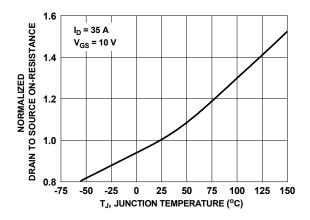


Figure 3. Normalized On Resistance vs Junction Temperature

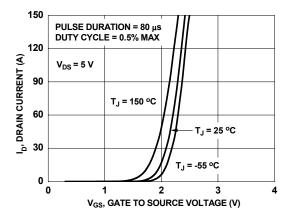


Figure 5. Transfer Characteristics

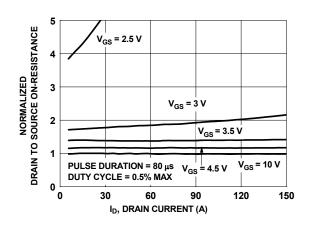


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

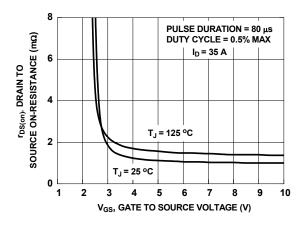


Figure 4. On-Resistance vs Gate to Source Voltage

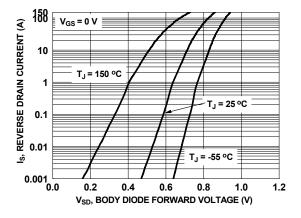


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25 $^{\circ}$ C unless otherwise noted

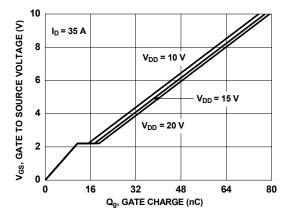


Figure 7. Gate Charge Characteristics

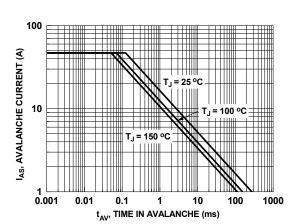


Figure 9. Unclamped Inductive Switching Capability

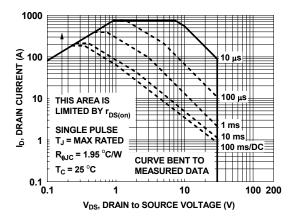


Figure 11. Forward Bias Safe Operating Area

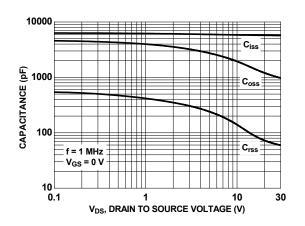


Figure 8. Capacitance vs Drain to Source Voltage

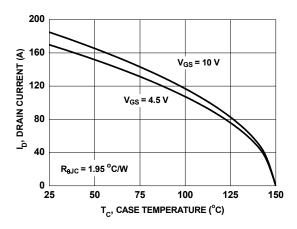


Figure 10. Maximum Continuous Drain Current vs Case Temperature

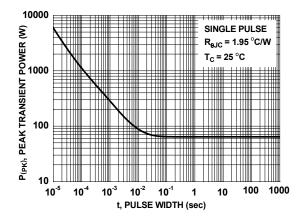


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25$ °C unless otherwise noted

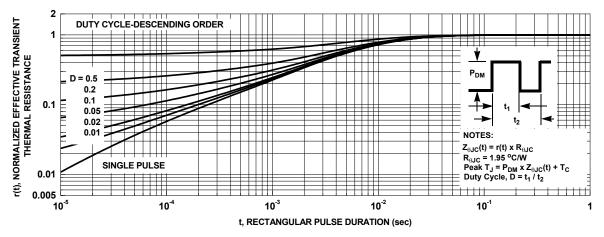
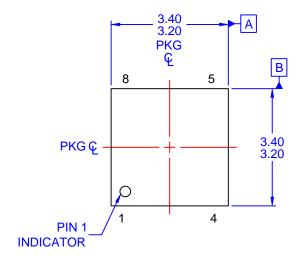
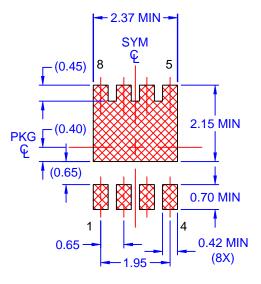
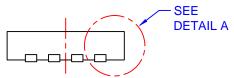


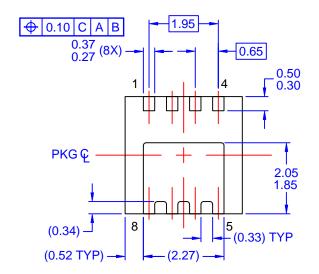
Figure 13. Junction-to-Case Transient Thermal Response Curve





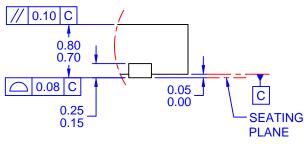


LAND PATTERN RECOMMENDATION



NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE STANDARD REFERENCE: JEDEC MO-240, ISSUE A, VAR. BA, DATED OCTOBER 2002.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. MOLD FLASH OR BURRS DOES NOT EXCEED 0.10MM.
- D) DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- E) DRAWING FILE NAME: PQFN08HREV1



DETAIL A
SCALE: 2X

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